PRELIMINARY CALL FOR PAPERS

**CyberC 2018**

The 10th International Conference on Cyber-Enabled Distributed Computing and Knowledge Discovery

**Zhengzhou, China, October 18 - 20, 2018**

[www.Cyberc.org](http://www.Cyberc.org)


Sponsored by Zhengzhou University, Tech Mahindra, Huawei, AT&T, InfoBeyond, IEEE Big Data Initiative, IEEE SDN Initiative

The Proceedings will be published by IEEE (EI &Explore)

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**Scopes:** CyberC promotes in-depth exploration of the most recent research and developments in the field of big data, distributed computing, clouds, cyber security, pervasive computing, mobile computing, Internet of Things, and other cyber-based technologies. Scientists, engineers, and students in the areas are encouraged to participate. CyberC also welcomes the participation of the industry to showcase and commercialize their relevant technology and products.

**Zhengzhou:** The 10th CyberC will be held in Zhengzhou, China.

**Summits:** CyberC 2018 co-hosts Emerging Technology Summit (AI, Big Data, 5G) forum that emphasizes innovative and state-of-art R&D, industry products, specifications, showcases, tutorial, technical transitions, and markets.

**Tour:** One or two-day tours will be scheduled for local historical sites (Shaolin temple (Chinese martial arts, a.k.a., Shaolin Kung Fu), Longmen Grottoes, Luoyang, Yellow river).

**Topics:** The topics of interests include, but not limited to:
- Big Data, big data analytics, decision-making
- AI and Applications
- Cyber, Internet of things, localization, and distributed computing
- 5G, wireless networks, RF, wireless communications, and mobile computing
- Cyber surveillance and cyber physical systems
- Cloud Computing and mobile clouds
- Wireless Communications
- Cyber security and privacy, cyber trust, cyber agility, and cyber assurance

**Co-hosted Workshops:** CyberC 2018 incorporates four workshops:
- Big Data 2018: The 5th International Workshop on Big Data
- Security 2018: The 6th workshop on Cyber Security and Privacy
- ALL 2018: The 1st workshop on Artificial Intelligence and Learning
- IOT 2018: The 2st International Workshop on Internet of Things and Future Communication Technologies
- Smart Sensor Network: The 6th workshop on Smart Cities Enabling Technologies.

**INFORMATION FOR AUTHORS**
The CyberC 2018 Proceedings will be published by IEEE CPS. **Full papers** for CyberC 2018 must not exceed 10 pages of IEEE 2-column format, while **short papers** must not exceed 4 pages. Please visit the conference web site at [http://www.cyberc.org](http://www.cyberc.org) for precise formatting and submission instructions.

**IMPORTANT DATES**
Submission deadline for full (10-page) and/or short (4-page) papers: May 30, 2018 Notification of acceptance: July 30, 2018 Camera-ready deadline: August 20, 2018

**AUTHOR CONTACTS**
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**Paper Submission:** [http://edas.info/N24399](http://edas.info/N24399) or Login EDAS at http://edas.info/ by selecting “CyberC 2018”. Electronic submission to papers@cyberc.org with a title of “CyberC 2018 Submission” is also accepted.

**Become a sponsor, contact:**
Chi-Ming Chen at cc5421@att.com

**Become a TPC or other roles, contact:**
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**EVENTS**
Emerging Technology Summit: October 18, 2018.

**Keynotes (Partial List):**
Alok Srivastava, Lead Architect, Microsoft Corp., USA
Chih-Lin I, Chief Scientist, Wireless Technologies, China Mobile Research Institute
Feifei Gao, Tsing Hua University, Beijing, China
Yang Yang, Shanghai Institute of Microsystem and Information Technology, Chinese Academy of Sciences

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**CyberC 2017 Data:** Number of submissions: 293, Number of full papers: 57, Number of Short Papers: 37, Number of Reviewers: 150, Number of Attendees: 145, Number of Sessions: 10, Number of Keynotes: 13, Scholars in CyberC: 221, Scholars in Big Data: 259.

**CyberC QQ Group:** 426380304; Big Data Group: 208385582

**Emerging Technology Summit Site:** [http://www.cyberc.org/bigdata/](http://www.cyberc.org/bigdata/)

**Summit Invited Speakers:** TBD

**Conference Web Site:** [www.Cyberc.org](http://www.Cyberc.org)

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